

08-31-1998

To the Honorable Assistant Secretary and Co
document(s) or copy(ies) thereof.

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100768745

1. Name of conveying party(ies):

MRD 8-8-96

Nobuaki KIDO; Shunichi MATSUMURA; and Takashi ITO

Additional name(s) of conveying party(ies) attached? No

2. Name and address of receiving party(ies):

Name: Teijin Limited

Internal Address:

Street Address: 6-7, Minamihommachi 1-chome,
Chuo-kuCity: Osaka-shi, Osaka 541, JAPAN State: ZIP: Additional name(s) & address(es) attached? No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other ☐Execution Date: July 29, 1996

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: July 29, 1996

A. Patent Application No.(s)

08/694274

Additional numbers attached? No

B. Patent No.(s)

5. Name and address of party to whom correspondence
concerning document should be mailed:Name: WENDEROTH, LIND & PONACK
Attn: Matthew Jacob, Esq.Street Address: 805 15th Street, N.W., Suite 700City: Washington, State: DC ZIP: 200056. Total number of applications and patents involved:
One7. Total fee (37 C.F.R. § 3.41). \$40.00☒ Enclosed (Check No.)
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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Matthew Jacob, Reg. No. 25,154
Name of Person Signing

Signature

August 8, 1996
Date

40E

Total number of pages including cover sheet: Three

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PATENT

REEL: 9263 FRAME: 0884

Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

**Insert Name(s)
of Inventor(s)** Nobuaki KIDO, Shunichi MATSUMURA and Takashi ITO,
all citizens of Japan, of Iwakuni-shi, Yamaguchi, Japan,
respectively,

and

the undersigned hereby sell(s) and assign(s) to

**Insert Name
of Assignee** TEIJIN LIMITED
Address 6-7, Minamihommachi 1-chome, Chuo-ku, Osaka-shi,
of OSAKA 541 JAPAN

(hereinafter designated as the Assignee) the entire right, title and interest for the United States of America as defined in 35 USC 100, in the invention known as

**Title of
Invention** THERMOPLASTIC RESIN COMPOSITION SUPERIOR IN TRANSPARENCY
AND ANTISTATIC PROPERTY

for which an application for patent in the United States of America has been executed by the undersigned

**Date of Signing
of Application** on July 29, 1996

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, Southern Building, Suite 700, 805 Fifteenth Street, N.W., Washington, D.C. 20005, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date July 29, 1996, Name of Inventor Nobuaki Kido

Date July 29, 1996, Name of Inventor Shusaku Matsumura

Date July 29, 1996, Name of Inventor Takashi Ito

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Yoshihito Matsui

Witness Mitsuru Hiyama

ACKNOWLEDGMENT

_____ } ss
_____ }

This _____ day of _____, 19____, before me
personally came the above-named _____

to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U. S. Application Serial No. _____, Filing Date _____

Applicant Reference Number _____, Atty. Docket No. _____

Title of Invention _____